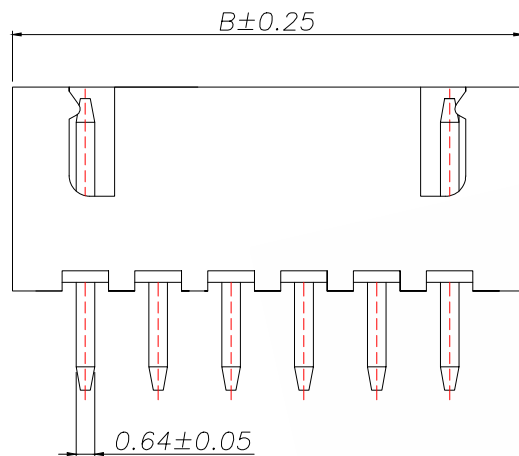
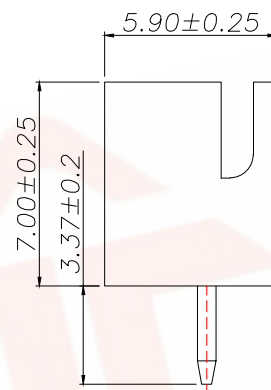


SUGGESTED PCB LAYOUT
(COMPONENT SIDE)



技术要求:

1. 塑件材料:PA66(UL-94V-0)
2. 接触件:黄铜镀锡
3. 接触电阻: $\leq 10m\Omega$
4. 绝缘电阻: $\geq 100M\Omega$
5. 额定电压:250V AC DC
6. 额定电流:2.0A AC DC
7. 耐压:能承受1000V AC/Minute
8. 工作温度: $-25^{\circ}\sim+85^{\circ}$
9. 可焊性试验:浸锡面积 $\geq 95\%$ 温度 $235\pm 5^{\circ}$,时间 2.5 ± 0.5 秒
10. 铅和镉等六大有害物质含量要符合环保要求.

REV.	ECN NO.	DESCRIPTION	DATE	DESIGN

Part No	Pin	A	B
AXHB-2A-11	2	2.50	7.50
AXHB-3A-11	3	5.00	10.00
AXHB-4A-11	4	7.50	12.50
AXHB-5A-11	5	10.00	15.00
AXHB-6A-11	6	12.50	17.50
AXHB-7A-11	7	15.00	20.00
AXHB-8A-11	8	17.50	22.50
AXHB-9A-11	9	20.00	25.00
AXHB-10A-11	10	22.50	27.50
AXHB-11A-11	11	25.00	30.00
AXHB-12A-11	12	27.50	32.50
AXHB-13A-11	13	30.00	35.00
AXHB-14A-11	14	32.50	37.50
AXHB-15A-11	15	35.00	40.00
AXHB-16A-11	16	37.50	42.50
AXHB-17A-11	17	40.00	45.00
AXHB-18A-11	18	42.50	47.50
AXHB-19A-11	19	45.00	50.00
AXHB-20A-11	20	47.50	52.50

2	端子Contact	黄铜	N*1	电镀(锡):整个表面镀底镍 30u"MIN,再镀锡80u"MIN
1	基座Wafer	PA66(UL94 V-0)	1	白色
序号	名称	材料	数量	备注

TOLERANCE			深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.X	±0.20	X.* ±10°	PART NO.		TITLE: XH2.54MM 直针	
.XX	±0.10	.X* ± 8°	AXHB-XA-11			
.XXX	±0.05	.XX* ± 5°				
UNITS		mm	DESIGN: Ethan		MANUFACTURE DWG	
MATERILA		— — —	CHED: Olvia			
FINISH		— — —	APPD: Ava			
					SCALE N:A	SHEET 1/1